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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon NPN Triple Diffused

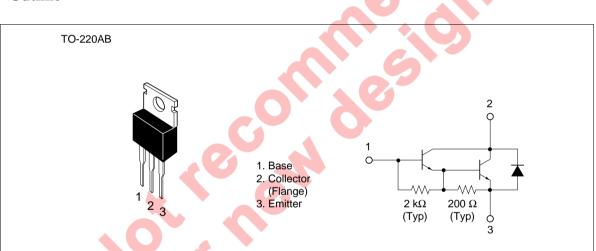


ADE-208-901 (Z) 1st. Edition September 2000

#### Application

Medium speed and power switching complementary pair with 2SB791(K)

#### Outline



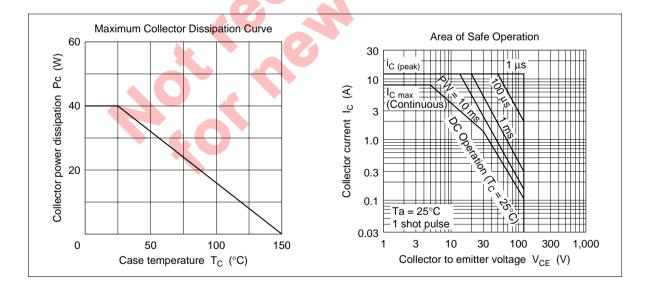
#### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

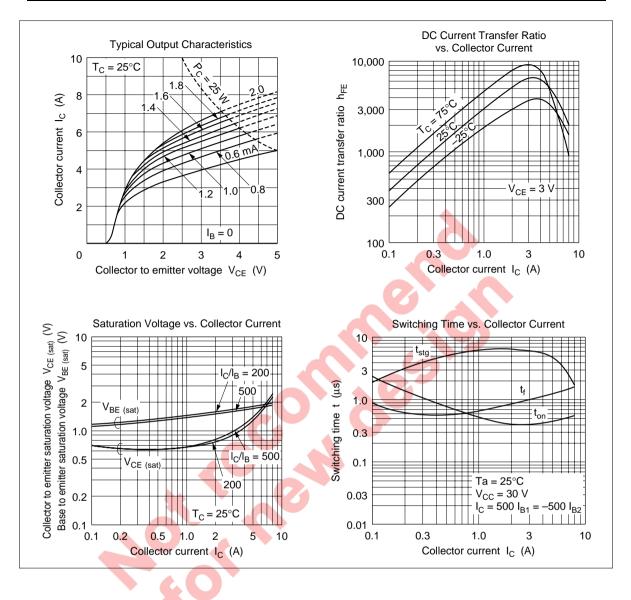
Item	Symbol	Ratings	Unit	
Collector to base voltage	V <sub>CBO</sub>	120	V	_
Collector to emitter voltage	V <sub>CEO</sub>	120	V	
Emitter to base voltage	V <sub>EBO</sub>	7	V	
Collector current	Ι <sub>c</sub>	8	А	
Collector peak current	I <sub>C(peak)</sub>	12	А	
Collector power dissipation	P <sub>c</sub> * <sup>1</sup>	40	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

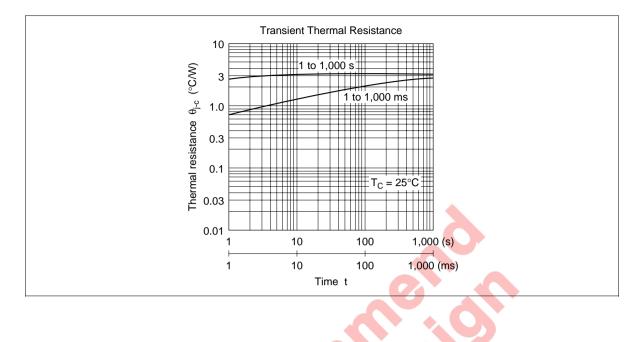
Note: 1. Value at  $T_c = 25^{\circ}C$ .

#### **Electrical Characteristics** (Ta = 25°C)

ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	120	_	_	V	$I_{c}$ = 25 mA, $R_{BE}$ = $\infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	7	_	_	V	$I_{\rm E} = 50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I <sub>CBO</sub>	—	—	100	μΑ	$V_{CB} = 120 \text{ V}, \text{ I}_{E} = 0$
	I <sub>CEO</sub>	—	—	10	μA	V <sub>CE</sub> = 100 V, R <sub>BE</sub> = ∞
DC current transfer ratio	h <sub>FE</sub>	1000	—	20000		$V_{ce} = 3 \text{ V}, \text{ I}_{c} = 4 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE}(\text{sat})1}$	—	—	1.5	V	$I_{\rm c} = 4 \text{ A}, I_{\rm B} = 8 \text{ mA}^{*1}$
voltage	$V_{\text{CE(sat)2}}$	—	—	3.0	V	I <sub>c</sub> = 8 A, I <sub>B</sub> = 80 mA*1
Base to emitter saturation	$V_{\text{BE(sat)1}}$	—	—	2.0	V	$I_{\rm C} = 4  {\rm A},  I_{\rm B} = 8  {\rm m} {\rm A}^{*1}$
voltage	$V_{\text{BE(sat)2}}$	—	-	3.5	V	$I_{\rm C} = 8 \text{ A}, I_{\rm B} = 80 \text{ mA}^{*1}$
Turn on time	t <sub>on</sub>	—	0.4	-	μs	$I_{c} = 4 \text{ A}, I_{B1} = -I_{B2} = 8 \text{ mA}$
Storage time	t <sub>stg</sub>	—	5.4	—	μs	T
Fall time	t <sub>f</sub>	-	1.1	-	μs	_
Note: 1. Pulse test.						







RENESAS

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#### Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

#### For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071

